Features

- **Single Voltage Read/Write Operation: 2.65V to 3.3V (BV), 3.0V to 3.6V (LV)**
- **Access Time – 70 ns**
- **Sector Erase Architecture**
  - **Thirty-one 32K Word (64K Bytes) Sectors with Individual Write Lockout**
  - **Eight 4K Word (8K Bytes) Sectors with Individual Write Lockout**
- **Fast Word Program Time – 20 µs**
- **Fast Sector Erase Time – 300 ms**
- **Suspend/Resume Feature for Erase and Program**
  - **Supports Reading and Programming from Any Sector by Suspending Erase of a Different Sector**
  - **Supports Reading Any Byte/Word by Suspending Programming of Any Other Byte/Word**
- **Low-power Operation**
  - **30 mA Active**
  - **10 µA Standby**
- **$\overline{\text{Data}}$ Polling, Toggle Bit, Ready/$\overline{\text{Busy}}$ for End of Program Detection**
- **VPP Pin for Write Protection and Accelerated Program/Erase Operations**
- **$\overline{\text{RESET}}$ Input for Device Initialization**
- **Sector Lockdown Support**
- **TSOP and CBGA Package Options**
- **Top or Bottom Boot Block Configuration Available**
- **128-bit Protection Register**

Description

The AT49BV/LV16X(T) is a 3.0-volt 16-megabit Flash memory organized as 1,048,576 words of 16 bits each or 2,097,152 bytes of 8 bits each. The x16 data appears on I/O0 - I/O15; the x8 data appears on I/O0 - I/O7. The memory is divided into 39 sectors for erase operations. The device is offered in a 48-lead TSOP, 45-ball and 48-ball CBGA packages. The device has $\overline{\text{CE}}$ and $\overline{\text{OE}}$ control signals to avoid any bus contention. This device can be read or reprogrammed using a single 2.65V power supply, making it ideally suited for in-system programming.

Pin Configurations

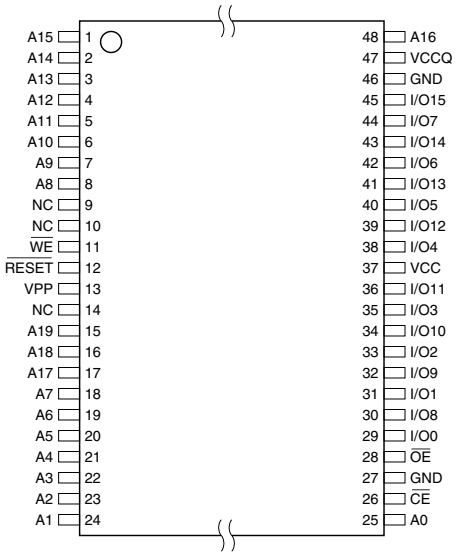
Pin Name	Function
A0 - A19	Addresses
$\overline{\text{CE}}$	Chip Enable
$\overline{\text{OE}}$	Output Enable
$\overline{\text{WE}}$	Write Enable
$\overline{\text{RESET}}$	Reset
RDY/$\overline{\text{BUSY}}$	READY/$\overline{\text{BUSY}}$ Output
VPP	Write Protection and Power Supply for Accelerated Program/Erase Operations
I/O0 - I/O14	Data Inputs/Outputs
I/O15 (A-1)	I/O15 (Data Input/Output, Word Mode) A-1 (LSB Address Input, Byte Mode)
$\overline{\text{BYTE}}$	Selects Byte or Word Mode
NC	No Connect
VCCQ	Output Power Supply

16-megabit (1M x 16/2M x 8) 3-volt Only Flash Memory

AT49BV160
AT49LV160
AT49BV160T
AT49BV161
AT49LV161
AT49BV161T
AT49LV161T

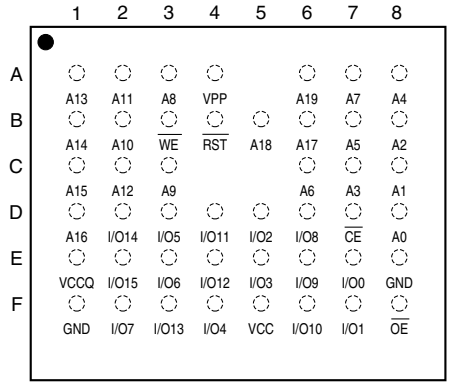
Rev. 1427L–FLASH–02/03

TSOP Top View
Type 1

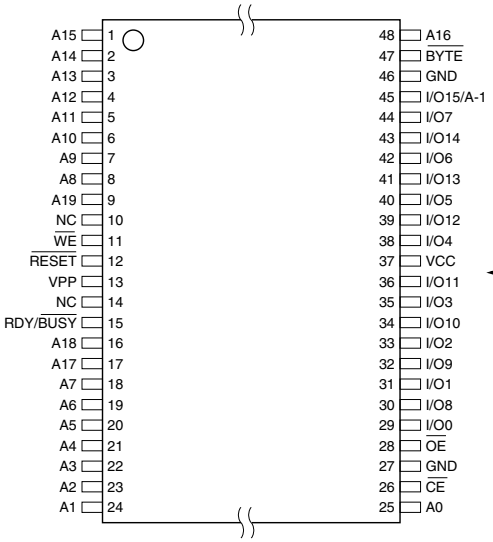


AT49BV/LV160(T)

CBGA Top View

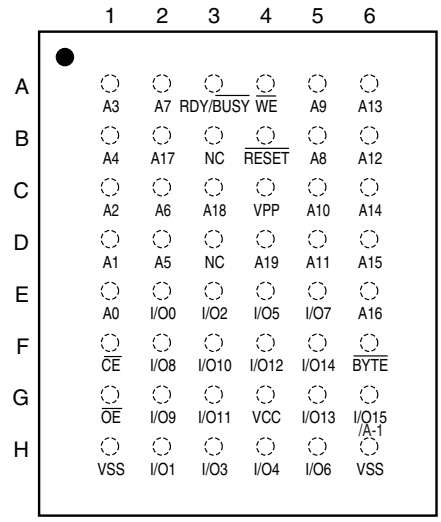


TSOP Top View
Type 1



AT49BV/LV161(T)

CBGA Top View



The device powers on in the read mode. Command sequences are used to place the device in other operation modes such as program and erase. The device has the capability to protect the data in any sector. (See “Sector Lockdown” section.)

To increase the flexibility of the device, it contains an Erase Suspend and Program Suspend feature. This feature will put the Erase or Program on hold for any amount of time and let the user read data from or program data to any of the remaining sectors within the memory. The end of a program or an erase cycle is detected by the Ready/$\overline{\text{Busy}}$ pin, $\overline{\text{Data}}$ Polling or by the toggle bit.

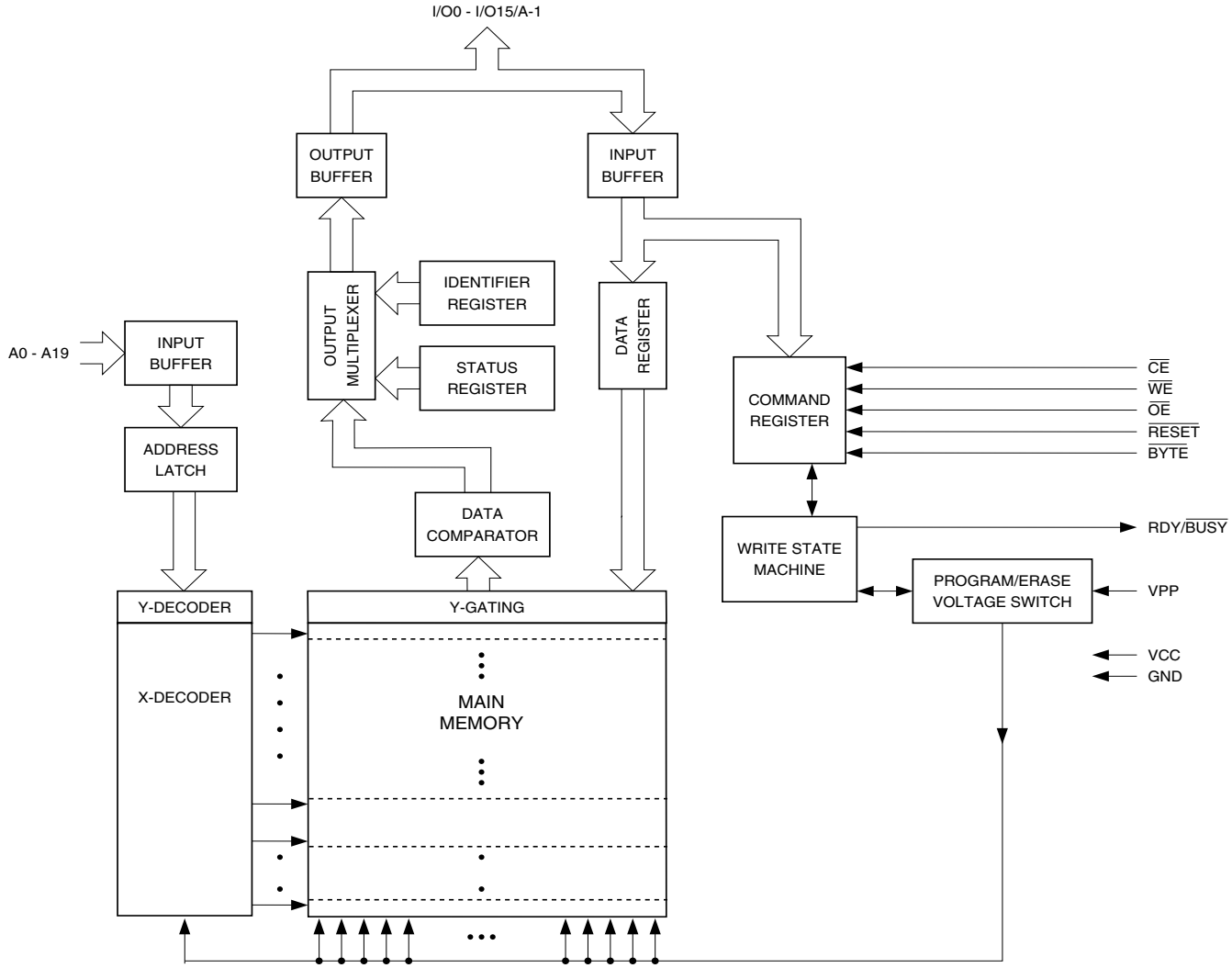
The VPP pin provides data protection and faster programming. When the V_{PP} input is below 0.8V, the program and erase functions are inhibited. When V_{PP} is at 1.65V or above, normal program and erase operations can be performed. With V_{PP} at 5.0V or 12.0V, the program and erase operations are accelerated.

A six-byte command (Enter Single Pulse Program Mode) sequence to remove the requirement of entering the three-byte program sequence is offered to further improve programming time. After entering the six-byte code, only single pulses on the write control lines are required for writing into the device. This mode (Single Pulse Byte/Word Program) is exited by powering down the device, or by pulsing the $\overline{\text{RESET}}$ pin low for a minimum of 500 ns and then bringing it back to V_{CC}. Erase, Erase Suspend/Resume, and Program Suspend/Resume commands will not work while in this mode; if entered they will result in data being programmed into the device. It is not recommended that the six-byte code reside in the software of the final product but only exist in external programming code.

When using the AT49BV/LV160(T) pinout configuration, the device always operates in the word mode. In the AT49BV/LV161(T) configuration, the $\overline{\text{BYTE}}$ pin controls whether the device data I/O pins operate in the byte or word configuration. If the $\overline{\text{BYTE}}$ pin is set at logic “1”, the device is in word configuration, I/O0 - I/O15 are active and controlled by $\overline{\text{CE}}$ and $\overline{\text{OE}}$.

If the $\overline{\text{BYTE}}$ pin is set at logic “0”, the device is in byte configuration, and only data I/O pins I/O0 - I/O7 are active and controlled by $\overline{\text{CE}}$ and $\overline{\text{OE}}$. The data I/O pins I/O8 - I/O14 are tri-stated, and the I/O15 pin is used as an input for the LSB (A-1) address function.

Block Diagram



Device Operation

READ: The AT49BV/LV16X(T) is accessed like an EPROM. When $\overline{CE}$ and $\overline{OE}$ are low and $\overline{WE}$ is high, the data stored at the memory location determined by the address pins are asserted on the outputs. The outputs are put in the high-impedance state whenever $\overline{CE}$ or $\overline{OE}$ is high. This dual-line control gives designers flexibility in preventing bus contention.

COMMAND SEQUENCES: When the device is first powered on, it will be reset to the read or standby mode, depending upon the state of the control line inputs. In order to perform other device functions, a series of command sequences are entered into the device. The command sequences are shown in the "Command Definition in Hex" table on page 13 (I/O8 - I/O15 are don't care inputs for the command codes). The command sequences are written by applying a low pulse on the $\overline{WE}$ or $\overline{CE}$ input with $\overline{CE}$ or $\overline{WE}$ low (respectively) and $\overline{OE}$ high. The address is latched on the falling edge of $\overline{CE}$ or $\overline{WE}$, whichever occurs last. The data is latched by the first rising edge of $\overline{CE}$ or $\overline{WE}$. Standard microprocessor write timings are used. The address locations used in the command sequences are not affected by entering the command sequences.

RESET: A $\overline{RESET}$ input pin is provided to ease some system applications. When $\overline{RESET}$ is at a logic high level, the device is in its standard operating mode. A low level on the $\overline{RESET}$ input halts the present device operation and puts the outputs of the device in a high-impedance state. When a high level is reasserted on the $\overline{RESET}$ pin, the device returns to the read or standby mode, depending upon the state of the control inputs.

ERASURE: Before a byte/word can be reprogrammed, it must be erased. The erased state of memory bits is a logical "1". The entire device can be erased by using the Chip Erase command or individual sectors can be erased by using the Sector Erase command.

CHIP ERASE: The entire device can be erased at one time by using the six-byte chip erase software code. After the chip erase has been initiated, the device will internally time the erase operation so that no external clocks are required. The maximum time to erase the chip is t_{EC}.

If the sector lockdown has been enabled, the chip erase will not erase the data in the sector that has been locked out; it will erase only the unprotected sectors. After the chip erase, the device will return to the read or standby mode.

SECTOR ERASE: As an alternative to a full chip erase, the device is organized into 39 sectors (SA0 - SA38) that can be individually erased. The Sector Erase command is a six-bus cycle operation. The sector address is latched on the falling $\overline{WE}$ edge of the sixth cycle while the 30H data input command is latched on the rising edge of $\overline{WE}$. The sector erase starts after the rising edge of $\overline{WE}$ of the sixth cycle. The erase operation is internally controlled; it will automatically time to completion. The maximum time to erase a sector is t_{SEC}. When the sector programming lockdown feature is not enabled, the sector will erase (from the same Sector Erase command). An attempt to erase a sector that has been protected will result in the operation terminating in 2 µs.

BYTE/WORD PROGRAMMING: Once a memory block is erased, it is programmed (to a logical "0") on a byte-by-byte or on a word-by-word basis. Programming is accomplished via the internal device command register and is a four-bus cycle operation. The device will automatically generate the required internal program pulses.

Any commands written to the chip during the embedded programming cycle will be ignored. If a hardware reset happens during programming, the data at the location being programmed will be corrupted. Please note that a data "0" cannot be programmed back to a "1"; only erase operations can convert "0"s to "1"s. Programming is completed after the specified t_{BP} cycle time. The $\overline{\text{Data}}$ Polling feature or the Toggle Bit feature may be used to indicate the end of a program cycle. If the erase/program status bit is a "1", the device was not able to verify that the erase or program operation was performed successfully.

VPP PIN: The circuitry of the AT49BV/LV16X(T) is designed so that the device can be programmed or erased from the V_{CC} power supply or from the VPP input pin. When V_{PP} is greater than 1.65V and less than or equal to the VCC pin, the device selects the V_{CC} supply for programming and erase operations. When the VPP pin is greater than the V_{CC} supply, the device will select the V_{PP} input as the power supply for programming and erase operations. The device will allow for some variations between the V_{PP} input and the V_{CC} power supply in its selection of V_{CC} or V_{PP} for program or erase operations. If the VPP pin is within 0.3V of V_{CC} for $2.65V < V_{CC} < 3.6V$, then the program or erase operations will use V_{CC} and disregard the V_{PP} input signal. When the V_{PP} signal is used for program and erase operations, the V_{PP} must be in the 5V ± 0.5V or 12V ± 0.5V range to ensure proper operation. The V_{pp} pin cannot be left floating.

PROGRAM/ERASE STATUS: The device provides several bits to determine the status of a program or erase operation: I/O2, I/O3, I/O5, I/O6 and I/O7. The "Status Bit Table" on page 12 and the following four sections describe the function of these bits. To provide greater flexibility for system designers, the AT49BV/LV16X(T) contains a programmable configuration register. The configuration register allows the user to specify the status bit operation. The configuration register can be set to one of two different values, "00" or "01". If the configuration register is set to "00", the part will automatically return to the read mode after a successful program or erase operation. If the configuration register is set to a "01", a Product ID Exit command must be given after a successful program or erase operation before the part will return to the read mode. It is important to note that whether the configuration register is set to a "00" or to a "01", any unsuccessful program or erase operation requires using the Product ID Exit command to return the device to read mode. The default value (after power-up) for the configuration register is "00". Using the four-bus cycle Set Configuration Register command as shown in the "Command Definition in Hex" table on page 13, the value of the configuration register can be changed. Voltages applied to the $\overline{\text{RESET}}$ pin will not alter the value of the configuration register. The value of the configuration register will affect the operation of the I/O7 status bit as described below.

$\overline{\text{DATA}}$ POLLING: The AT49BV/LV16X(T) features $\overline{\text{Data}}$ Polling to indicate the end of a program cycle. If the status configuration register is set to a "00", during a program cycle an attempted read of the last byte/word loaded will result in the complement of the loaded data on I/O7. Once the program cycle has been completed, true data is valid on all outputs and the next cycle may begin. During a chip or sector erase operation, an attempt to read the device will give a "0" on I/O7. Once the program or erase cycle has completed, true data will be read from the device. $\overline{\text{Data}}$ Polling may begin at any time during the program cycle. Please see "Status Bit Table" on page 12 for more details.

If the status bit configuration register is set to a “01”, the I/O7 status bit will be low while the device is actively programming or erasing data. I/O7 will go high when the device has completed a program or erase operation. Once I/O7 has gone high, status information on the other pins can be checked.

The $\overline{\text{Data}}$ Polling status bit must be used in conjunction with the erase/program and V_{PP} status bit as shown in the algorithm in Figures 1 and 2 on page 10.

TOGGLE BIT: In addition to $\overline{\text{Data}}$ Polling, the AT49BV/LV16X(T) provides another method for determining the end of a program or erase cycle. During a program or erase operation, successive attempts to read data from the memory will result in I/O6 toggling between one and zero. Once the program cycle has completed, I/O6 will stop toggling and valid data will be read. Examining the toggle bit may begin at any time during a program cycle. Please see “Status Bit Table” on page 12 for more details.

The toggle bit status bit should be used in conjunction with the erase/program and V_{PP} status bit as shown in the algorithm in Figures 3 and 4 on page 11.

ERASE/PROGRAM STATUS BIT: The device offers a status bit on I/O5, which indicates whether the program or erase operation has exceeded a specified internal pulse count limit. If the status bit is a “1”, the device is unable to verify that an erase or a byte/word program operation has been successfully performed. The device may also output a “1” on I/O5 if the system tries to program a “1” to a location that was previously programmed to a “0”. Only an erase operation can change a “0” back to a “1”. If a program (Sector Erase) command is issued to a protected sector, the protected sector will not be programmed (erased). The device will go to a status read mode and the I/O5 status bit will be set high, indicating the program (erase) operation did not complete as requested. Once the erase/program status bit has been set to a “1”, the system must write the Product ID Exit command to return to the read mode. The erase/program status bit is a “0” while the erase or program operation is still in progress. Please see “Status Bit Table” on page 12 for more details.

V_{PP} STATUS BIT: The AT49BV/LV16X(T) provides a status bit on I/O3, which provides information regarding the voltage level of the VPP pin. During a program or erase operation, if the voltage on the VPP pin is not high enough to perform the desired operation successfully, the I/O3 status bit will be a “1”. Once the V_{PP} status bit has been set to a “1”, the system must write the Product ID Exit command to return to the read mode. On the other hand, if the voltage level is high enough to perform a program or erase operation successfully, the V_{PP} status bit will output a “0”. Please see “Status Bit Table” on page 12 for more details.

SECTOR LOCKDOWN: Each sector has a programming lockdown feature. This feature prevents programming of data in the designated sectors once the feature has been enabled. These sectors can contain secure code that is used to bring up the system. Enabling the lockdown feature will allow the boot code to stay in the device while data in the rest of the device is updated. This feature does not have to be activated; any sector’s usage as a write-protected region is optional to the user.

At power-up or reset, all sectors are unlocked. To activate the lockdown for a specific sector, the six-bus cycle Sector Lockdown command must be issued. Once a sector has been locked down, the contents of the sector is read-only and cannot be erased or programmed.

SECTOR LOCKDOWN DETECTION: A software method is available to determine if programming of a sector is locked down. When the device is in the software product identification mode (see “Software Product Identification Entry/Exit” sections on page 24), a read from address location 00002H within a sector will show if programming the sector is locked down. If the data on I/O0 is low, the sector can be programmed; if the data on I/O0 is high, the program lockdown feature has been enabled and the sector cannot be programmed. The software product identification exit code should be used to return to standard operation.

SECTOR LOCKDOWN OVERRIDE: The only way to unlock a sector that is locked down is through reset or power-up cycles. After power-up or reset, the content of a sector that is locked down can be erased and reprogrammed.

ERASE SUSPEND/ERASE RESUME: The Erase Suspend command allows the system to interrupt a sector erase or chip erase operation and then program or read data from a different sector within the memory. After the Erase Suspend command is given, the device requires a maximum time of 15 µs to suspend the erase operation. After the erase operation has been suspended, the system can then read data or program data to any other sector within the device. An address is not required during the Erase Suspend command. During a sector erase suspend, another sector cannot be erased. To resume the sector erase operation, the system must write the Erase Resume command. The Erase Resume command is a one-bus cycle command. The device also supports an erase suspend during a complete chip erase. While the chip erase is suspended, the user can read from any sector within the memory that is protected. The command sequence for a chip erase suspend and a sector erase suspend are the same.

PROGRAM SUSPEND/PROGRAM RESUME: The Program Suspend command allows the system to interrupt a programming operation and then read data from a different byte/word within the memory. After the Program Suspend command is given, the device requires a maximum of 15 µs to suspend the programming operation. After the programming operation has been suspended, the system can then read data from any other byte/word within the device. An address is not required during the program suspend operation. To resume the programming operation, the system must write the Program Resume command. The program suspend and resume are one-bus cycle commands. The command sequence for the erase suspend and program suspend are the same, and the command sequence for the erase resume and program resume are the same.

PRODUCT IDENTIFICATION: The product identification mode identifies the device and manufacturer as Atmel. It may be accessed by hardware or software operation. The hardware operation mode can be used by an external programmer to identify the correct programming algorithm for the Atmel product.

For details, see “Operating Modes” on page 17 (for hardware operation) or “Software Product Identification Entry/Exit” on page 24. The manufacturer and device codes are the same for both modes.

128-BIT PROTECTION REGISTER: The AT49BV/LV16X(T) contains a 128-bit register that can be used for security purposes in system design. The protection register is divided into two 64-bit blocks. The two blocks are designated as block A and block B. The data in block A is non-changeable and is programmed at the factory with a unique number. The data in block B is programmed by the user and can be locked out such that data in the block cannot be reprogrammed. To program block B in the protection register, the four-bus cycle Program Protection Register command must be used as shown in the “Command Definition in Hex” table on page 13. To lock out block B, the four-bus cycle Lock Protection Register command must be used as shown in the “Command Definition in Hex” table on page 13. Data bit D1 must be zero during the fourth bus cycle. All other data bits during the fourth bus cycle are don’t cares. To determine whether block B is locked out, the Product ID Entry command is given followed by a read operation from address 80H. If data bit D1 is zero, block B is locked. If data bit D1 is one, block B can be reprogrammed. Please see the “Protection Register Addressing Table” on page 14 for the address locations in the protection register. To read the protection register, the Product ID Entry command is given followed by a normal read operation from an address within the protection register. After determining whether block B is protected or not, or reading the protection register, the Product ID Exit command must be given prior to performing any other operation.

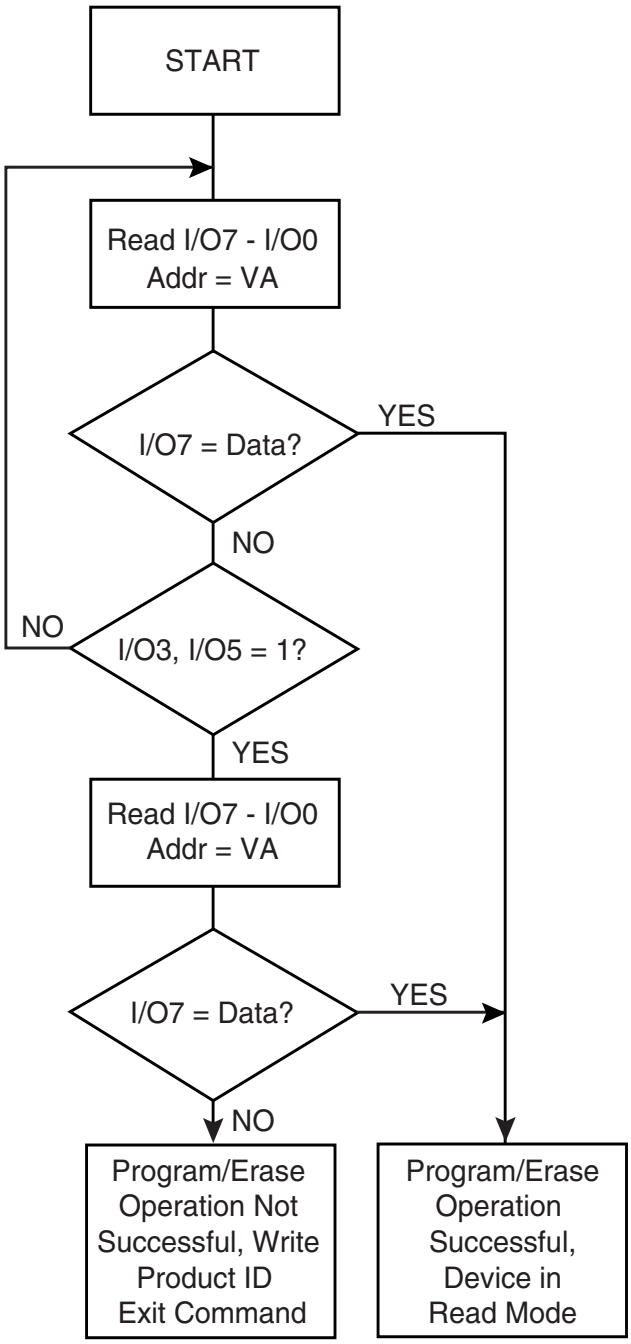
RDY/$\overline{\text{BUSY}}$: For the AT49BV/LV161(T), an open-drain READY/$\overline{\text{BUSY}}$ output pin provides another method of detecting the end of a program or erase operation. RDY/$\overline{\text{BUSY}}$ is actively pulled low during the internal program and erase cycles and is released at the completion of the cycle. The open-drain connection allows for OR-tying of several devices to the same RDY/$\overline{\text{BUSY}}$ line. Please see “Status Bit Table” on page 12 for more details.

HARDWARE DATA PROTECTION: The Hardware Data Protection feature protects against inadvertent programs to the AT49BV/LV16X(T) in the following ways: (a) V_{CC} sense: if V_{CC} is below 1.8V (typical), the program function is inhibited. (b) V_{CC} power-on delay: once V_{CC} has reached the V_{CC} sense level, the device will automatically time out 10 ms (typical) before programming. (c) Program inhibit: holding any one of $\overline{\text{OE}}$ low, $\overline{\text{CE}}$ high or $\overline{\text{WE}}$ high inhibits program cycles. (d) Noise filter: pulses of less than 15 ns (typical) on the $\overline{\text{WE}}$ or $\overline{\text{CE}}$ inputs will not initiate a program cycle. (e) Program inhibit: V_{PP} is less than V_{ILPP}. (f) V_{PP} power-on delay: once V_{PP} has reached 1.65V, program and erase operations can occur after 100 ns.

INPUT LEVELS: While operating with a 2.65V to 3.6V power supply, the address inputs and control inputs ($\overline{\text{OE}}$, $\overline{\text{CE}}$ and $\overline{\text{WE}}$) may be driven from 0 to 5.5V without adversely affecting the operation of the device. The I/O lines can only be driven from 0 to V_{CC} + 0.6V.

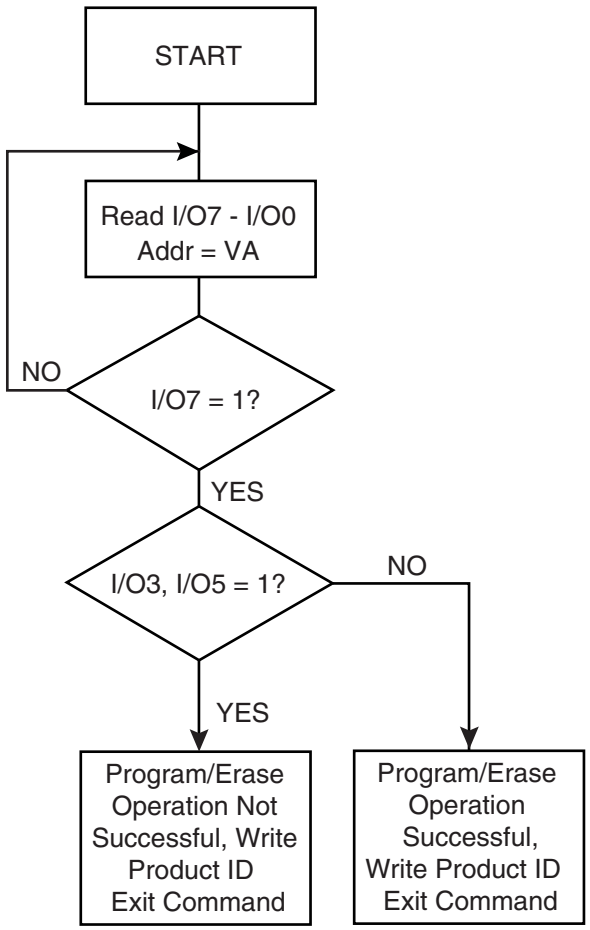
OUTPUT LEVELS: For the AT49BV/LV160(T), output high levels (V_{OH}) are equal to V_{CCQ} - 0.2V (not V_{CC}). For 2.65V - 3.6V output levels, V_{CCQ} must be tied to V_{CC}. For 1.8V - 2.2V output levels, V_{CCQ} must be regulated to 2.0V ± 10%, while V_{CC} must be regulated to 2.65V - 3.0V (for minimum power).

Figure 1. $\overline{\text{Data}}$ Polling Algorithm (Configuration Register = 00)



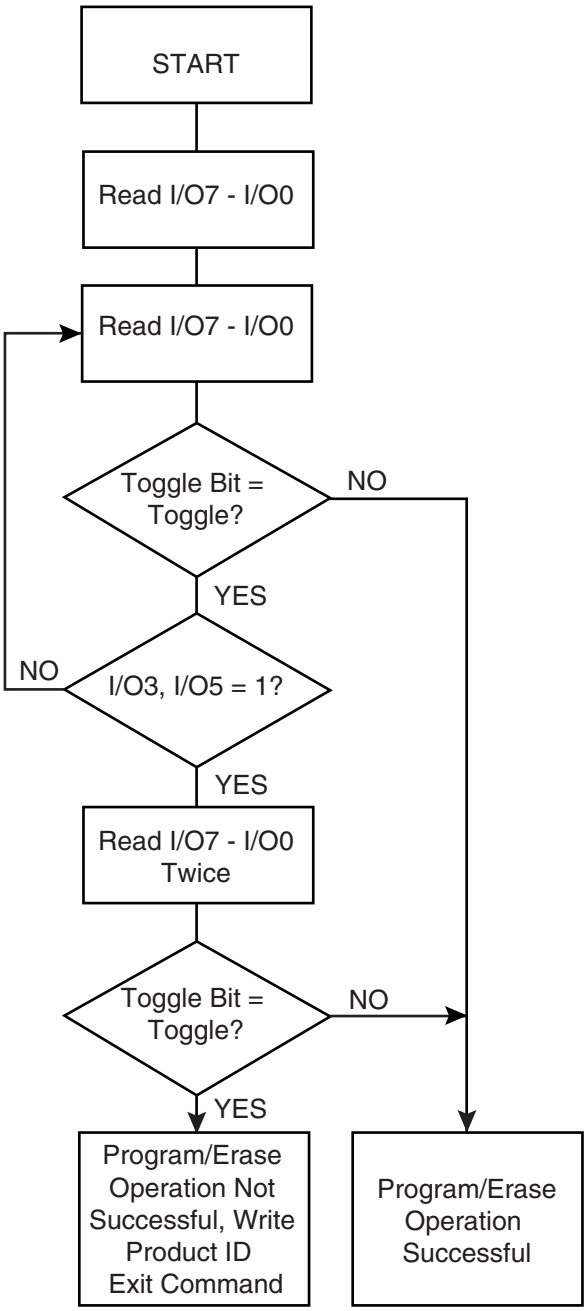
Notes:
1. VA = Valid address for programming. During a sector erase operation, a valid address is any sector address within the sector being erased. During chip erase, a valid address is any non-protected sector address.
2. I/O7 should be rechecked even if I/O5 = "1" because I/O7 may change simultaneously with I/O5.

Figure 2. $\overline{\text{Data}}$ Polling Algorithm (Configuration Register = 01)



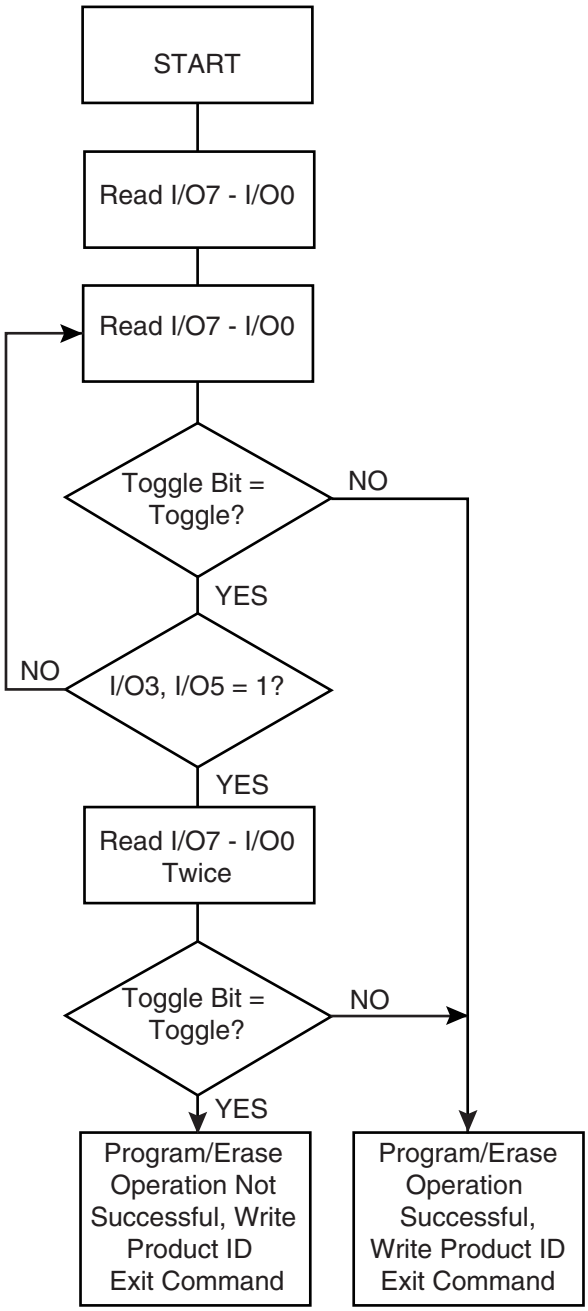
Note:
1. VA = Valid address for programming. During a sector erase operation, a valid address is any sector address within the sector being erased. During chip erase, a valid address is any non-protected sector address.

Figure 3. Toggle Bit Algorithm (Configuration Register = 00)



Note: 1. The system should recheck the toggle bit even if I/O5 = “1” because the toggle bit may stop toggling as I/O5 changes to “1”.

Figure 4. Toggle Bit Algorithm (Configuration Register = 01)



Note: 1. The system should recheck the toggle bit even if I/O5 = “1” because the toggle bit may stop toggling as I/O5 changes to “1”.

Status Bit Table

	Status Bit						
	I/O7	**I/O7**	**I/O6**	**I/O5**[1]	**I/O3**[2]	**I/O2**	**RDY/$\overline{\text{BUSY}}$**
Configuration Register:	**00**	**01**	**00/01**	**00/01**	**00/01**	**00/01**	**00/01**
Programming	$\overline{\text{I/O7}}$	0	TOGGLE	0	0	1	0
Erasing	0	0	TOGGLE	0	0	TOGGLE	0
Erase Suspended & Read Erasing Sector	1	1	1	0	0	TOGGLE	1
Erase Suspended & Read Non-erasing Sector	DATA	DATA	DATA	DATA	DATA	DATA	1
Erase Suspended & Program Non-erasing Sector	$\overline{\text{I/O7}}$	0	TOGGLE	0	0	TOGGLE	0

Notes: 1. I/O5 switches to a “1” when a program or an erase operation has exceeded the maximum time limits or when a program or sector erase operation is performed on a protected sector.
2. I/O3 switches to a “1” when the V_{PP} level is not high enough to successfully perform program and erase operations.

Command Definition in Hex[1]

Command Sequence	Bus Cycles	1st Bus Cycle		2nd Bus Cycle		3rd Bus Cycle		4th Bus Cycle		5th Bus Cycle		6th Bus Cycle	
		Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data
Read	1	Addr	D_{OUT}										
Chip Erase	6	555	AA	AAA[2]	55	555	80	555	AA	AAA	55	555	10
Sector Erase	6	555	AA	AAA	55	555	80	555	AA	AAA	55	SA[3][4]	30
Byte/Word Program	4	555	AA	AAA	55	555	A0	Addr	D_{IN}				
Enter Single Pulse Program Mode	6	555	AA	AAA	55	555	80	555	AA	AAA	55	555	A0
Single Pulse Byte/Word Program	1	Addr	D_{IN}										
Sector Lockdown	6	555	AA	AAA	55	555	80	555	AA	AAA	55	SA[3][4]	60
Erase/Program Suspend	1	XXX	B0										
Erase/Program Resume	1	XXX	30										
Product ID Entry	3	555	AA	AAA	55	555	90						
Product ID Exit[5]	3	555	AA	AAA	55	555	F0						
Product ID Exit[5]	1	XXX	F0										
Program Protection Register	4	555	AA	AAA	55	555	C0	Addr	D_{IN}				
Lock Protection Register - Block B	4	555	AA	AAA	55	555	C0	080	X0				
Status of Block B Protection	4	555	AA	AAA	55	555	90	80	D_{OUT}[6]				
Set Configuration Register	4	555	AA	AAA	55	555	D0	XXX	00/01[7]				

Notes:
1. The DATA FORMAT shown for each bus cycle is as follows; I/O7 - I/O0 (Hex). In word operation I/O15 - I/O8 are Don't Care. The ADDRESS FORMAT shown for each bus cycle is as follows: A11 - A0 (Hex). Address A19 through A11 are Don't Care in the word mode. Address A19 through A11 and A-1 are Don't Care in the byte mode.
2. Since A11 is a Don't Care, AAA can be replaced with 2AA.
3. SA = sector address. Any byte/word address within a sector can be used to designate the sector address (see pages 15 and 16 for details).
4. Once a sector is in the lockdown mode, data in the protected sector cannot be changed unless the chip is reset or power cycled.
5. Either one of the Product ID Exit commands can be used.
6. If data bit D1 is "0", block B is locked. If data bit D1 is "1", block B can be reprogrammed.
7. The default state (after power-up) of the configuration register is "00".

Absolute Maximum Ratings*

Temperature under Bias ..... -55°C to +125°C

Storage Temperature ..... -65°C to +150°C

All Input Voltages
(including NC Pins)
with Respect to Ground .....-0.6V to +6.25V

All Output Voltages
with Respect to Ground .....-0.6V to V_{CC} + 0.6V

Voltage on $\overline{OE}$ and V_{PP}
with Respect to Ground .....-0.6V to +13.0V

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Protection Register Addressing Table

Word	Use	Block	A7	A6	A5	A4	A3	A2	A1	A0
0	Factory	A	1	0	0	0	0	0	0	1
1	Factory	A	1	0	0	0	0	0	1	0
2	Factory	A	1	0	0	0	0	0	1	1
3	Factory	A	1	0	0	0	0	1	0	0
4	User	B	1	0	0	0	0	1	0	1
5	User	B	1	0	0	0	0	1	1	0
6	User	B	1	0	0	0	0	1	1	1
7	User	B	1	0	0	0	1	0	0	0

Note: 1. All address lines not specified in the above table must be “0” when accessing the protection register, i.e., A19 - A8 = 0.

AT49BV/LV160/161 – Sector Address Table

Sector	Size (Bytes/Words)	x8 Address Range (A19 - A-1)	x16 Address Range (A19 - A0)
SA0	8K/4K	000000 - 001FFF	00000 - 00FFF
SA1	8K/4K	002000 - 003FFF	01000 - 01FFF
SA2	8K/4K	004000 - 005FFF	02000 - 02FFF
SA3	8K/4K	006000 - 007FFF	03000 - 03FFF
SA4	8K/4K	008000 - 009FFF	04000 - 04FFF
SA5	8K/4K	00A000 - 00BFFF	05000 - 05FFF
SA6	8K/4K	00C000 - 00DFFF	06000 - 06FFF
SA7	8K/4K	00E000 - 00FFFF	07000 - 07FFF
SA8	64K/32K	010000 - 01FFFF	08000 - 0FFFF
SA9	64K/32K	020000 - 02FFFF	10000 - 17FFF
SA10	64K/32K	030000 - 03FFFF	18000 - 1FFFF
SA11	64K/32K	040000 - 04FFFF	20000 - 27FFF
SA12	64K/32K	050000 - 05FFFF	28000 - 2FFFF
SA13	64K/32K	060000 - 06FFFF	30000 - 37FFF
SA14	64K/32K	070000 - 07FFFF	38000 - 3FFFF
SA15	64K/32K	080000 - 08FFFF	40000 - 47FFF
SA16	64K/32K	090000 - 09FFFF	48000 - 4FFFF
SA17	64K/32K	0A0000 - 0AFFFF	50000 - 57FFF
SA18	64K/32K	0B0000 - 0BFFFF	58000 - 5FFFF
SA19	64K/32K	0C0000 - 0CFFFF	60000 - 67FFF
SA20	64K/32K	0D0000 - 0DFFFF	68000 - 6FFFF
SA21	64K/32K	0E0000 - 0EFFFF	70000 - 77FFF
SA22	64K/32K	0F0000 - 0FFFFF	78000 - 7FFFF
SA23	64K/32K	100000 - 10FFFF	80000 - 87FFF
SA24	64K/32K	110000 - 11FFFF	88000 - 8FFFF
SA25	64K/32K	120000 - 12FFFF	90000 - 97FFF
SA26	64K/32K	130000 - 13FFFF	98000 - 9FFFF
SA27	64K/32K	140000 - 14FFFF	A0000 - A7FFF
SA28	64K/32K	150000 - 15FFFF	A8000 - AFFFF
SA29	64K/32K	160000 - 16FFFF	B0000 - B7FFF
SA30	64K/32K	170000 - 17FFFF	B8000 - BFFFF
SA31	64K/32K	180000 - 18FFFF	C0000 - C7FFF
SA32	64K/32K	190000 - 19FFFF	C8000 - CFFFF
SA33	64K/32K	1A0000 - 1AFFFF	D0000 - D7FFF
SA34	64K/32K	1B0000 - 1BFFFF	D8000 - DFFFF
SA35	64K/32K	1C0000 - 1CFFFF	E0000 - E7FFF
SA36	64K/32K	1D0000 - 1DFFFF	E8000 - EFFFF
SA37	64K/32K	1E0000 - 1EFFFF	F0000 - F7FFF
SA38	64K/32K	1F0000 - 1FFFFF	F8000 - FFFFF

AT49BV/LV160T/161T – Sector Address Table

Sector	Size (Bytes/Words)	x8 Address Range (A19 - A-1)	x16 Address Range (A19 - A0)
SA0	64K/32K	000000 - 00FFFF	00000 - 07FFF
SA1	64K/32K	010000 - 01FFFF	08000 - 0FFFF
SA2	64K/32K	020000 - 02FFFF	10000 - 17FFF
SA3	64K/32K	030000 - 03FFFF	18000 - 1FFFF
SA4	64K/32K	040000 - 04FFFF	20000 - 27FFF
SA5	64K/32K	050000 - 05FFFF	28000 - 2FFFF
SA6	64K/32K	060000 - 06FFFF	30000 - 37FFF
SA7	64K/32K	070000 - 07FFFF	38000 - 3FFFF
SA8	64K/32K	080000 - 08FFFF	40000 - 47FFF
SA9	64K/32K	090000 - 09FFFF	48000 - 4FFFF
SA10	64K/32K	0A0000 - 0AFFFF	50000 - 57FFF
SA11	64K/32K	0B0000 - 0BFFFF	58000 - 5FFFF
SA12	64K/32K	0C0000 - 0CFFFF	60000 - 67FFF
SA13	64K/32K	0D0000 - 0DFFFF	68000 - 6FFFF
SA14	64K/32K	0E0000 - 0EFFFF	70000 - 77FFF
SA15	64K/32K	0F0000 - 0FFFFF	78000 - 7FFFF
SA16	64K/32K	100000 - 10FFFF	80000 - 87FFF
SA17	64K/32K	110000 - 11FFFF	88000 - 8FFFF
SA18	64K/32K	120000 - 12FFFF	90000 - 97FFF
SA19	64K/32K	130000 - 13FFFF	98000 - 9FFFF
SA20	64K/32K	140000 - 14FFFF	A0000 - A7FFF
SA21	64K/32K	150000 - 15FFFF	A8000 - AFFFF
SA22	64K/32K	160000 - 16FFFF	B0000 - B7FFF
SA23	64K/32K	170000 - 17FFFF	B8000 - BFFFF
SA24	64K/32K	180000 - 18FFFF	C0000 - C7FFF
SA25	64K/32K	190000 - 19FFFF	C8000 - CFFFF
SA26	64K/32K	1A0000 - 1AFFFF	D0000 - D7FFF
SA27	64K/32K	1B0000 - 1BFFFF	D8000 - DFFFF
SA28	64K/32K	1C0000 - 1CFFFF	E0000 - E7FFF
SA29	64K/32K	1D0000 - 1DFFFF	E8000 - EFFFF
SA30	64K/32K	1E0000 - 1EFFFF	F0000 - F7FFF
SA31	8K/4K	1F0000 - 1F1FFF	F8000 - F8FFF
SA32	8K/4K	1F2000 - 1F3FFF	F9000 - F9FFF
SA33	8K/4K	1F4000 - 1F5FFF	FA000 - FAFFF
SA34	8K/4K	1F6000 - 1F7FFF	FB000 - FBFFF
SA35	8K/4K	1F8000 - 1F9FFF	FC000 - FCFFF
SA36	8K/4K	1FA000 - 1FBFFF	FD000 - FDFFF
SA37	8K/4K	1FC000 - 1FDFFF	FE000 - FEFFF
SA38	8K/4K	1FE000 - 1FFFFF	FF000 - FFFFF

DC and AC Operating Range

		AT49BV/LV16X(T)-70	AT49BV/LV16X(T)-90
Operating Temperature (Case)	Ind.	-40°C - 85°C	-40°C - 85°C
V_{CC} Power Supply		2.65V to 3.3V/3.0V to 3.6V	2.65V to 3.3V/3.0V to 3.6V

Operating Modes

Mode	$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	$\overline{RESET}$	V_{PP}	Ai	I/O
Read	V_{IL}	V_{IL}	V_{IH}	V_{IH}	X	Ai	D_{OUT}
Program/Erase[2]	V_{IL}	V_{IH}	V_{IL}	V_{IH}	V_{IHPP}[6]	Ai	D_{IN}
Standby/Program Inhibit	V_{IH}	X[1]	X	V_{IH}	X	X	High-Z
Program Inhibit	X	X	V_{IH}	V_{IH}	X		
	X	V_{IL}	X	V_{IH}	X		
	X	X	X	V_{IH}	V_{ILPP}[7]		
Output Disable	X	V_{IH}	X	V_{IH}	X		High-Z
Reset	X	X	X	V_{IL}	X	X	High-Z
Product Identification							
Hardware	V_{IL}	V_{IL}	V_{IH}	V_{IH}		A1 - A19 = V_{IL}, A9 = V_H[3], A0 = V_{IL}	Manufacturer Code[4]
						A1 - A19 = V_{IL}, A9 = V_H[3], A0 = V_{IH}	Device Code[4]
Software[5]				V_{IH}		A0 = V_{IL}, A1 - A19 = V_{IL}	Manufacturer Code[4]
						A0 = V_{IH}, A1 - A19 = V_{IL}	Device Code[4]

Notes:
1. X can be V_{IL} or V_{IH}.
2. Refer to AC programming waveforms on page 23.
3. V_H = 12.0V ± 0.5V.
4. Manufacturer Code: 1FH (x8); 001FH (x16), Device Code: C0H (x8)-AT49BV/LV16X; 00C0H (x16)-AT49BV/LV16X; C2H (x8)-AT49BV/LV16XT; 00C2H (x16)-AT49BV/LV16XT.
5. See details under “Software Product Identification Entry/Exit” on page 24.
6. V_{IHPP} (min) = 1.65V; V_{IHPP} (max) = 3.6V. For faster erase/program operations, V_{PP} can be set to 5.0V ± 0.5V or 12V ± 0.5V.
7. V_{ILPP} (max) = 0.8V.

DC Characteristics

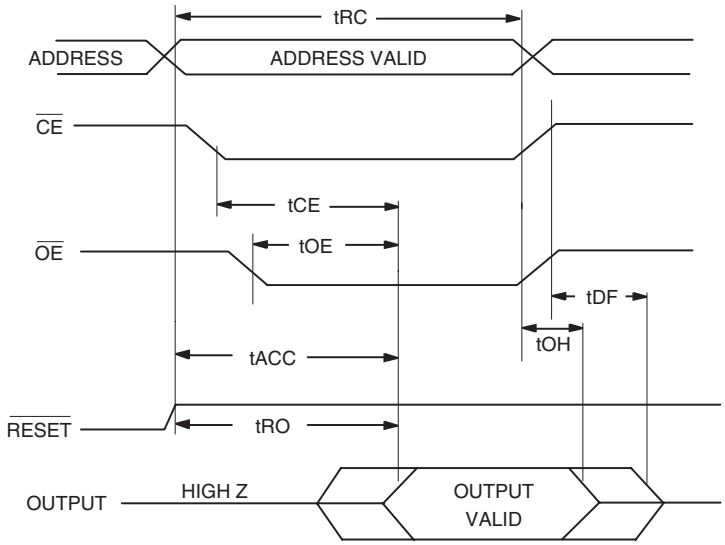
Symbol	Parameter	Condition	Min	Max	Units
I_{LI}	Input Load Current	V_{IN} = 0V to V_{CC}		10	µA
I_{LO}	Output Leakage Current	$V_{I/O}$ = 0V to V_{CC}		10	µA
I_{SB1}	V_{CC} Standby Current CMOS	$\overline{CE}$ = V_{CC} - 0.3V to V_{CC}		10	µA
I_{SB2}	V_{CC} Standby Current TTL	$\overline{CE}$ = 2.0V to V_{CC}		1	mA
I_{SB3}	V_{CC} Standby Current TTL	$\overline{CE}$ = 2.0V to V_{CC}, V_{CC} = 2.85V		10	µA
I_{CC} [1][2]	V_{CC} Active Read Current	f = 5 MHz; I_{OUT} = 0 mA, 3.3V≤ V_{CC}		30	mA
I_{CC1}	V_{CC} Programming Current (V_{PP} = V_{CC})			45	mA
I_{PP1}	V_{PP} Input Load Current	V_{PP} = 0V, V_{CC} = 3.0V		10	µA
		V_{PP} = V_{CC} = 3.0V		10	µA
I_{CC2}	V_{CC} Programming Current (V_{PP} = 5.0V ± 0.5V)			40	mA
I_{PP2}	V_{PP} Programming Current (V_{PP} = 5.0V ± 0.5V)			5	mA
I_{CC3}	V_{CC} Programming Current (V_{PP} = 12.0V ± 0.5V)			40	mA
I_{PP3}	V_{PP} Programming Current (V_{PP} = 12.0V ± 0.5V)			6	mA
V_{IL}	Input Low Voltage			0.6	V
V_{IH}	Input High Voltage		2.0		V
V_{OL1}	Output Low Voltage	I_{OL} = 2.1 mA		0.45	V
V_{OL2}	Output Low Voltage	I_{OL} = 1.0 mA		0.20	V
V_{OH1}	Output High Voltage	I_{OH} = -400 µA V_{CCQ} < 2.6V I_{OH} = -400 µA V_{CCQ} ≥ 2.6V I_{OH} = -400 µA	V_{CCQ} - 0.2 [AT49BV/LV160(T)] 2.4 [AT49BV/LV160(T)] 2.4 [AT49BV/LV161(T)]		V V V
V_{OH2}	Output High Voltage	I_{OH} = -100 µA V_{CCQ} < 2.6V I_{OH} = -100 µA V_{CCQ} ≥ 2.6V I_{OH} = -100 µA	V_{CCQ} - 0.1 [AT49BV/LV160(T)] 2.5 [AT49BV/LV160(T)] 2.5 [AT49BV/LV161(T)]		V V V

Notes: 1. In the erase mode, I_{CC} is 50 mA.
2. For 3.3V < V_{CC} < 3.6V, I_{CC} (max) = 35 mA

AC Read Characteristics

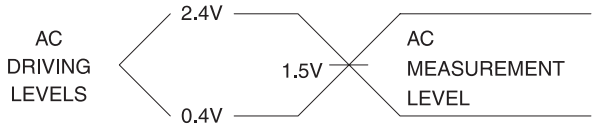
Symbol	Parameter	AT49BV/LV16X(T)-70		AT49BV/LV16X(T)-90		Units
		Min	Max	Min	Max	
t_{RC}	Read Cycle Time		70		90	ns
t_{ACC}	Address to Output Delay		70		90	ns
t_{CE}[1]	$\overline{CE}$ to Output Delay		70		90	ns
t_{OE}[2]	$\overline{OE}$ to Output Delay	0	35	0	40	ns
t_{DF}[3][4]	$\overline{CE}$ or $\overline{OE}$ to Output Float	0	25	0	25	ns
t_{OH}	Output Hold from $\overline{OE}$, $\overline{CE}$ or Address, whichever occurred first	0		0		ns
t_{RO}	$\overline{RESET}$ to Output Delay		100		100	ns

AC Read Waveforms[1][2][3][4]

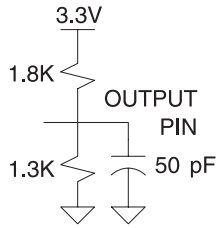


Notes:
1. $\overline{CE}$ may be delayed up to $t_{ACC} - t_{CE}$ after the address transition without impact on t_{ACC}.
2. $\overline{OE}$ may be delayed up to $t_{CE} - t_{OE}$ after the falling edge of $\overline{CE}$ without impact on t_{CE} or by $t_{ACC} - t_{OE}$ after an address change without impact on t_{ACC}.
3. t_{DF} is specified from $\overline{OE}$ or $\overline{CE}$, whichever occurs first (CL = 5 pF).
4. This parameter is characterized and is not 100% tested.

Input Test Waveforms and Measurement Level



Output Test Load



Pin Capacitance

f = 1 MHz, T = 25°C[1]

Symbol	Typ	Max	Units	Conditions
C_{IN}	4	6	pF	V_{IN} = 0V
C_{OUT}	8	12	pF	V_{OUT} = 0V

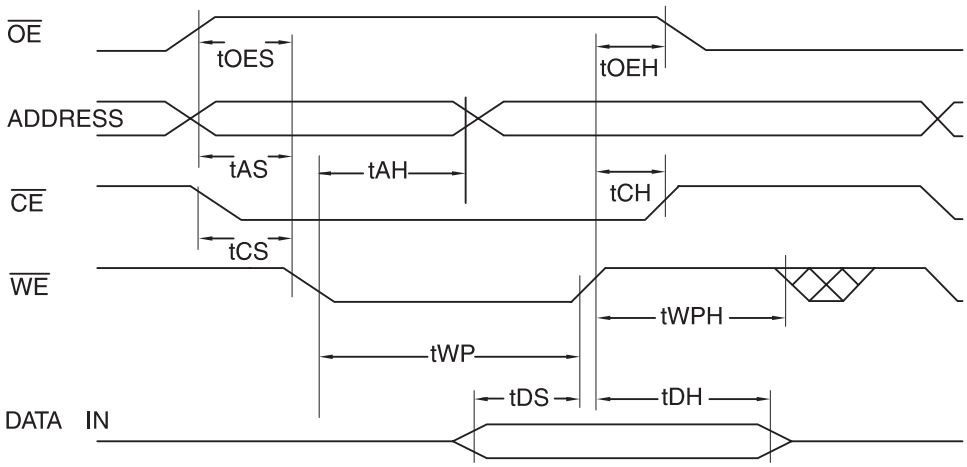
Note: 1. This parameter is characterized and is not 100% tested

AC Byte/Word Load Characteristics

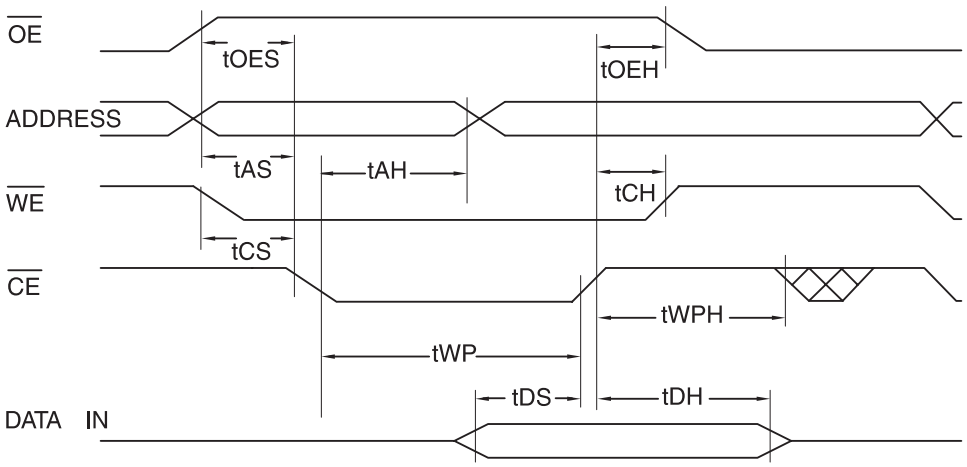
Symbol	Parameter	Min	Max	Units
t_{AS}, t_{OES}	Address, $\overline{OE}$ Setup Time	0		ns
t_{AH}	Address Hold Time	40		ns
t_{CS}	Chip Select Setup Time	0		ns
t_{CH}	Chip Select Hold Time	0		ns
t_{WP}	Write Pulse Width ($\overline{WE}$ or $\overline{CE}$)	40		ns
t_{DS}	Data Setup Time	30		ns
t_{DH}, t_{OEH}	Data, $\overline{OE}$ Hold Time	0		ns
t_{WPH}	Write Pulse Width High	30		ns

AC Byte/Word Load Waveforms

$\overline{WE}$ Controlled



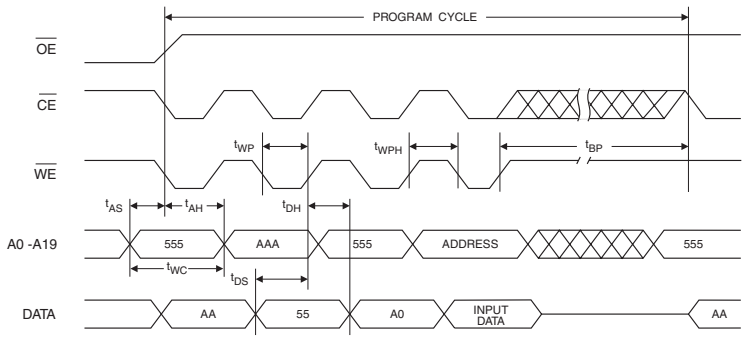
$\overline{CE}$ Controlled



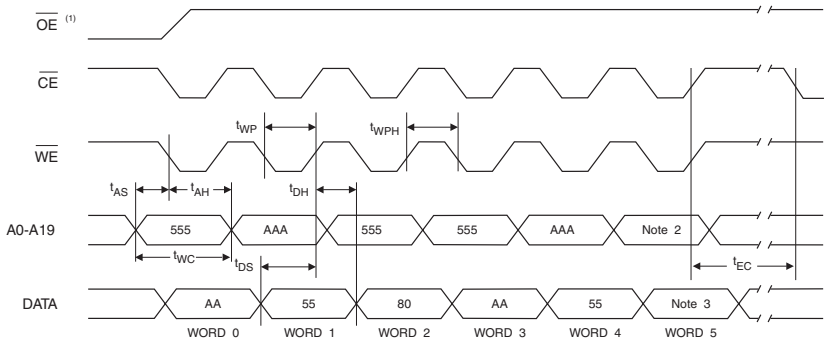
Program Cycle Characteristics

Symbol	Parameter	Min	Typ	Max	Units
t_{BP}	Byte/Word Programming Time ($V_{IHPP} < V_{PP} < 4.5V$)		20	200	µs
t_{BPVPP}	Byte/Word Programming Time ($V_{PP} \geq 4.5V$)		10	100	µs
t_{AS}	Address Setup Time	0			ns
t_{AH}	Address Hold Time	40			ns
t_{DS}	Data Setup Time	30			ns
t_{DH}	Data Hold Time	0			ns
t_{WP}	Write Pulse Width	40			ns
t_{WPH}	Write Pulse Width High	30			ns
t_{WC}	Write Cycle Time	70			ns
t_{RP}	$\overline{\text{Reset}}$ Pulse Width	500			ns
t_{RH}	$\overline{\text{Reset}}$ High Time before Read	50			ns
t_{EC}	Chip Erase Cycle Time ($V_{PP} < 4.5V$)			12	seconds
t_{ECVPP}	Chip Erase Cycle Time ($V_{PP} \geq 4.5V$)			6	seconds
t_{SEC}	Sector Erase Cycle Time		300	400	ms
t_{EPS}	Erase or Program Suspend Time			15	µs

Program Cycle Waveforms



Sector or Chip Erase Cycle Waveforms



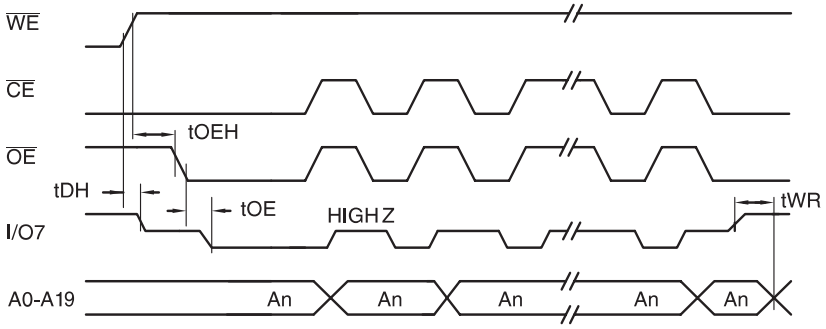
Notes:
1. $\overline{\text{OE}}$ must be high only when $\overline{\text{WE}}$ and $\overline{\text{CE}}$ are both low.
2. For chip erase, the address should be 555. For sector erase, the address depends on what sector is to be erased. (See note 3 under Command Definitions.)
3. For chip erase, the data should be 10H, and for sector erase, the data should be 30H.

$\overline{\text{Data}}$ Polling Characteristics[1]

Symbol	Parameter	Min	Typ	Max	Units
t_{DH}	Data Hold Time	10			ns
t_{OEH}	$\overline{OE}$ Hold Time	10			ns
t_{OE}	$\overline{OE}$ to Output Delay[2]				ns
t_{WR}	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested.
2. See t_{OE} spec in "AC Read Characteristics" on page 19.

$\overline{\text{Data}}$ Polling Waveforms

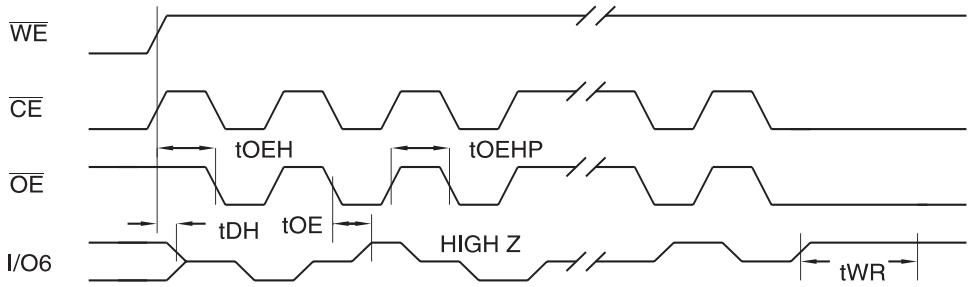


Toggle Bit Characteristics[1]

Symbol	Parameter	Min	Typ	Max	Units
t_{DH}	Data Hold Time	10			ns
t_{OEH}	$\overline{OE}$ Hold Time	10			ns
t_{OE}	$\overline{OE}$ to Output Delay[2]				ns
t_{OEHP}	$\overline{OE}$ High Pulse	50			ns
t_{WR}	Write Recovery Time	0			ns

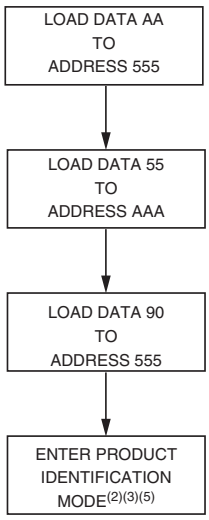
Notes: 1. These parameters are characterized and not 100% tested.
2. See t_{OE} spec in "AC Read Characteristics" on page 19.

Toggle Bit Waveforms[1][2][3]

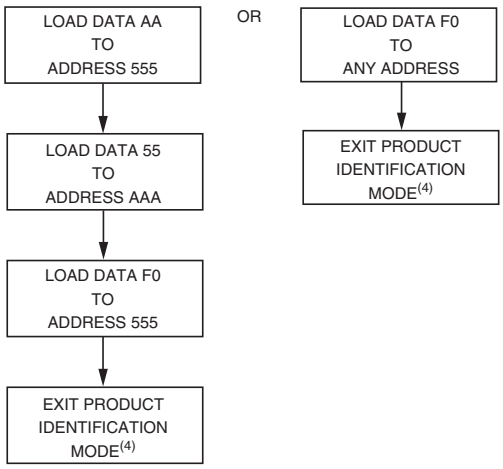


Notes: 1. Toggling either $\overline{OE}$ or $\overline{CE}$ or both $\overline{OE}$ and $\overline{CE}$ will operate toggle bit.
The t_{OEHP} specification must be met by the toggling input(s).
2. Beginning and ending state of I/O6 will vary.
3. Any address location may be used but the address should not vary.

Software Product Identification Entry[1]

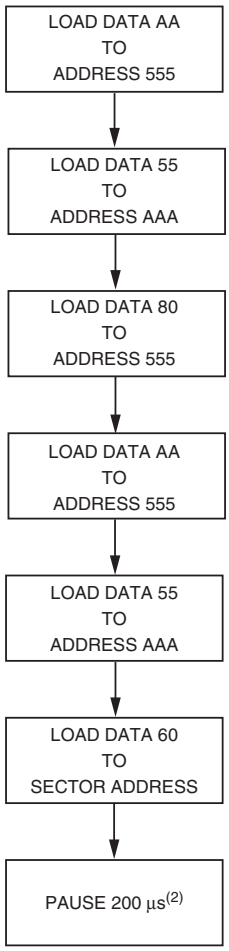


Software Product Identification Exit[1][6]



Notes:
1. Data Format: I/O15 - I/O8 (Don't Care); I/O7 - I/O0 (Hex) Address Format: A11 - A0 (Hex), A-1, and A11 - A19 (Don't Care).
2. A1 - A19 = V_{IL}. Manufacturer Code is read for A0 = V_{IL}; Device Code is read for A0 = V_{IH}. Additional Device Code is read for address 0003H
3. The device does not remain in identification mode if powered down.
4. The device returns to standard operation mode.
5. Manufacturer Code: 1FH(x8); 001FH(x16)
   Device Code: C0H (x8) - AT49BV/LV16X;
   00C0H (x16) - AT49BV/LV16X;
   C2H (x8) - AT49BV/LV16XT;
   00C2H (x16) - AT49BV/LV16XT.
   Additional Device Code: 08H (x8) - AT49BV/LV16X(T)
   0008H (x16) - AT49BV/LV16X(T)
6. Either one of the Product ID Exit commands can be used.

Sector Lockdown Enable Algorithm[1]



Notes:
1. Data Format: I/O15 - I/O8 (Don't Care); I/O7 - I/O0 (Hex) Address Format: A11 - A0 (Hex), A-1, and A11 - A19 (Don't Care).
2. Sector Lockdown feature enabled.

AT49BV160(T)/161(T) Ordering Information

t_{ACC} (ns)	I_{CC} (mA)		Ordering Code	Package	Operation Range
	Active	Standby			
70	25	0.01	AT49BV160-70CI AT49BV160-70TI	45C1 48T	Industrial (-40° to 85°C)
90	25	0.01	AT49BV160-90CI AT49BV160-90TI	45C1 48T	Industrial (-40° to 85°C)
70	25	0.01	AT49BV160T-70CI AT49BV160T-70TI	45C1 48T	Industrial (-40° to 85°C)
90	25	0.01	AT49BV160T-90CI AT49BV160T-90TI	45C1 48T	Industrial (-40° to 85°C)
70	25	0.01	AT49BV161-70CI AT49BV161-70TI	48C5 48T	Industrial (-40° to 85°C)
90	25	0.01	AT49BV161-90CI AT49BV161-90TI	48C5 48T	Industrial (-40° to 85°C)
70	25	0.01	AT49BV161T-70CI AT49BV161T-70TI	48C5 48T	Industrial (-40° to 85°C)
90	25	0.01	AT49BV161T-90CI AT49BV161T-90TI	48C5 48T	Industrial (-40° to 85°C)

AT49LV160(T)/161(T) Ordering Information

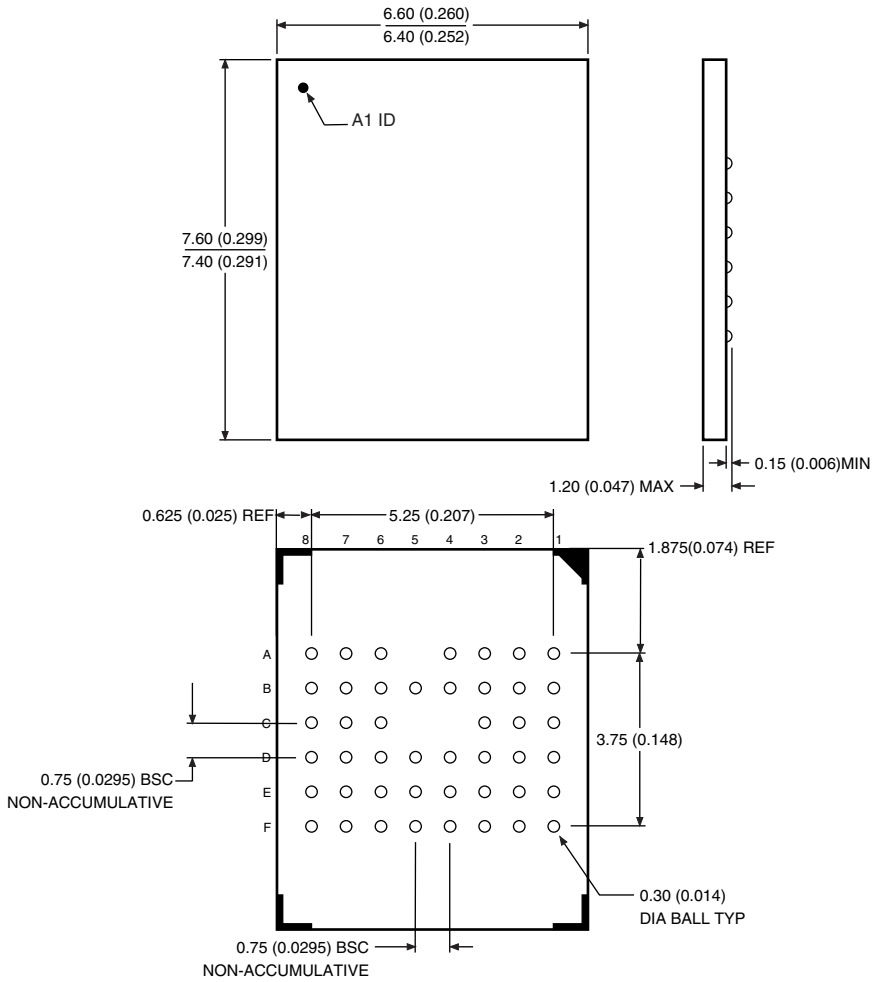
t_{ACC} (ns)	I_{CC} (mA)		Ordering Code	Package	Operation Range
	Active	Standby			
90	25	0.01	AT49LV160-90TI	48T	Industrial (-40° to 85°C)
70	25	0.01	AT49LV161-70CI AT49LV161-70TI	48C5 48T	Industrial (-40° to 85°C)
70	25	0.01	AT49LV161T-70CI AT49LV161T-70TI	48C5 48T	Industrial (-40° to 85°C)

Package Type	
45C1	45-ball, Plastic Chip-size Ball Grid Array Package (CBGA)
48C5	48-ball, Plastic Chip-size Ball Grid Array Package (CBGA)
48T	48-lead, Plastic Thin Small Outline Package (TSOP)

Packaging Information

45C1 – CBGA

Dimensions in Millimeters and (Inches).
Controlling dimension: millimeters.

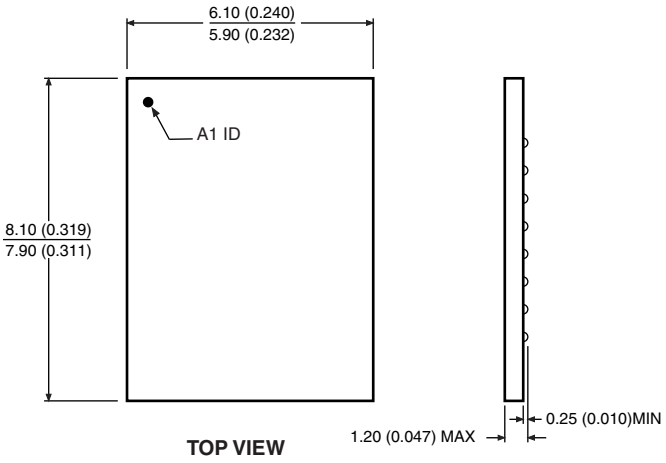


4/11/01

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**45C1**, 45-ball (8 x 6 Array), 0.75 mm Pitch, 6.5 x 7.5 x 1.2 mm Chip-scale Ball Grid Array Package (CBGA)	45C1	A

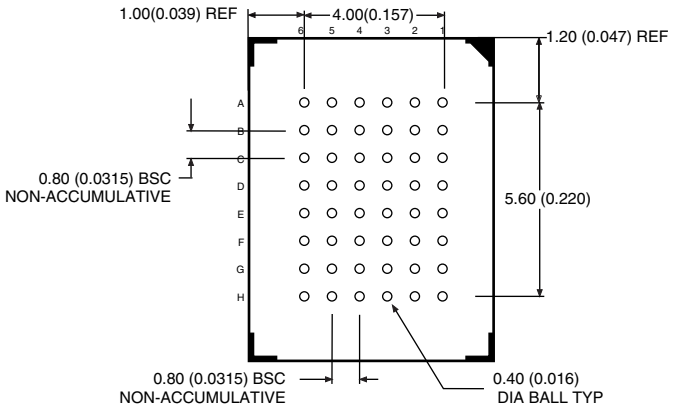
48C5 – CBGA

Dimensions in Millimeters and (Inches).
Controlling dimension: millimeters.



TOP VIEW

SIDE VIEW

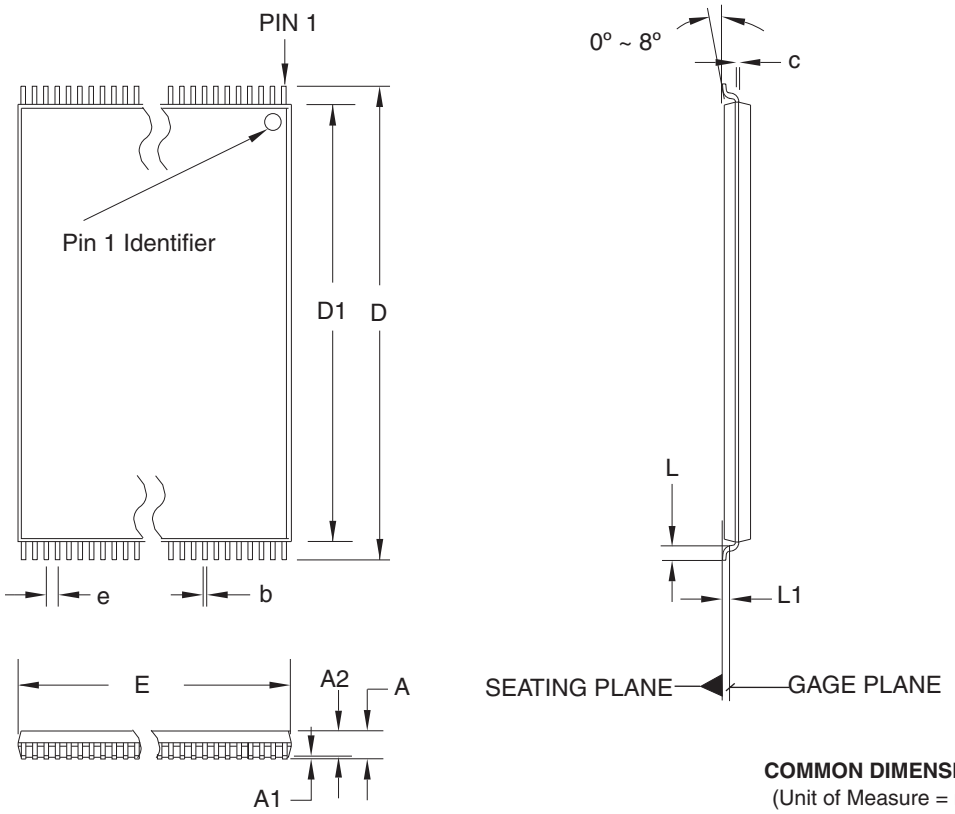


BOTTOM VIEW

10/18/01

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**48C5**, 48-ball (6 x 8 Array), 0.80 mm Pitch, 6 x 8 x 1.2 mm Chip-scale Ball Grid Array Package (CBGA)	48C5	A

48T – TSOP



COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	1.20	
A1	0.05	–	0.15	
A2	0.95	1.00	1.05	
D	19.80	20.00	20.20	
D1	18.30	18.40	18.50	Note 2
E	11.90	12.00	12.10	Note 2
L	0.50	0.60	0.70	
L1	0.25 BASIC			
b	0.17	0.22	0.27	
c	0.10	–	0.21	
e	0.50 BASIC			

Notes:
1. This package conforms to JEDEC reference MO-142, Variation DD.
2. Dimensions D1 and E do not include mold protrusion. Allowable protrusion on E is 0.15 mm per side and on D1 is 0.25 mm per side.
3. Lead coplanarity is 0.10 mm maximum.

10/18/01

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**48T**, 48-lead (12 x 20 mm Package) Plastic Thin Small Outline Package, Type I (TSOP)	48T	B

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